

MP62160/MP62161 3.3V/5V, Single-Channel 2A Current-Limited Power Distribution Switch with Output Discharge

DESCRIPTION

The MP62160/MP62161 Power Distribution Switch features internal current limiting to prevent damage to host devices due to faulty load conditions. The MP62160/MP62161 operates from a 3.3V or 5V nominal input voltage and includes an $85m\Omega$ Power MOSFET to handle up to 2A continuous load with a 2.8A typical current limit. The MP62160/MP62161 has built-in protection for both over current and increased thermal stress. For over-current protection (OCP), the device will limit the current by going into a constant current mode.

When continuous output overload condition exceeds power dissipation of the package, the thermal protection will shut the part off. The device will recover once the device temperature reduces to approx 120°C.

The MP62160/MP62161 involves a discharge function that provides a resistive discharge path for the external output capacitor when the part is disabled.

The MP62160/MP62161 is available in QFN8E, MSOP8E and SOIC8 packages.

FEATURES

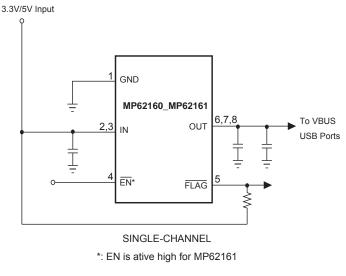
- 2A Continuous Current
- 2.8A accurate Current Limit
- Output Discharge Function
- 2.7V to 5.5V Supply Range
- 90uA Quiescent Current
- 85mΩ MOSFET
- Thermal-Shutdown Protection
- Under-Voltage Lockout
- 8ms FLAG Deglitch Time
- No FLAG Glitch During Power Up
- Reverse Current Blocking
- Active High & Active Low Options
- UL Recognized: E322138

APPLICATIONS

- Smartphone and PDA
- Portable GPS Device
- Notebook PC
- Set-top-box
- Telecom and Network Systems
- PC Card Hot Swap
- USB Power Distribution

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TYPICAL APPLICATION



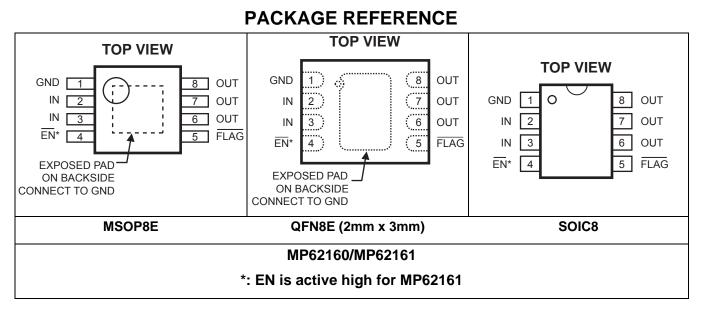




Part Number	Enable	Switch	Maximum Continuous Load Current	Typical Short- Circuit Current @ T _A =25C	Package	Top Marking	Temperature
MP62160DS	Active Low				SOIC8	62160DS	
MP62160DD					QFN8E (2mm x 3mm)	62160DD	
MP62160DH		Single	2A	2.8A	MSOP8E	62160DH	_40°C to +85°C
MP62161DS			5		SOIC8	62161DS	
MP62161DD	Active High				QFN8E (2mm x 3mm)	62161DD	
MP62161DH					MSOP8E	62161DH	

ORDERING INFORMATION

* For Tape & Reel, add suffix –Z (eg. MP62160DH–Z). For RoHS Compliant Packaging, add suffix –LF (eg. MP62160DH–L)



ABSOLUTE MAXIMUM RATINGS (1)

IN	0.3V to +6.0V
EN, FLAG, OUT to GND	0.3V to +6.0V
Continuous Power Dissipation	(T _A = +25°C) ⁽²⁾
MSOP8E	2.3W
QFN8E (2mm x 3mm)	2.3W
SOIC8	1.4W
Junction Temperature	150°C
Lead Temperature	260°C
Storage Temperature	–65°C to +150°C
Operating Temperature	–40°C to +85°C

Thermal Resistance ⁽³⁾	$\boldsymbol{\theta}_{JA}$	$\boldsymbol{\theta}_{JC}$	
MSOP8E	55	12	°C/W
QFN8E (2mm x 3mm)	55	12	°C/W
SOIC8	90	42	°C/W

Notes:

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature $T_J(MAX)$, the junction-toambient thermal resistance θ_{JA} , and the ambient temperature T_A . The maximum allowable continuous power dissipation at any ambient temperature is calculated by $P_D(MAX)=(T_J(MAX)-T_A)/\theta_{JA}$. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- 3) Measured on JESD51-7, 4-layer PCB.



ELECTRICAL CHARACTERISTICS (4)

 V_{IN} =5V, T_A =+25°C, unless otherwise noted.

Parameter	Condition	Min	Тур	Max	Units
IN Voltage Range		2.7		5.5	V
Supply Current	Device Active, I _{OUT} =0		90	120	μA
Shutdown Current	Device Disable, V _{OUT} =float, V _{IN} =5.5V		1		μA
Off Switch Leakage	Device Disable, V _{IN} =5.5V		1		μA
Current Limit		2.1	2.8	3.5	А
Trip Current	Current Ramp (slew rate≤100A/s) on Output		3.1	4	А
Under-voltage Lockout	Rising Edge	1.95		2.65	V
Under-voltage Hysteresis			250		mV
FET On Resistance	I _{OUT} =100mA (-40°C≤ T _A ≤85°C)		85	130	mΩ
EN Input Logic High Voltage		2			V
EN Input Logic Low Voltage				0.8	V
FLAG Output Logic Low Voltage	I _{SINK} =5mA			0.4	V
FLAG Output High Leakage Current	V _{IN} =V _{FLAG} =5.5V			1	μA
Thermal Shutdown			140		°C
Thermal Shutdown Hysteresis			20		°C
V _{OUT} Rising Time, Tr ⁽⁵⁾	V _{IN} =5.5V, CL=1uF, RL=5Ω		0.9		ms
	V _{IN} =2.7V, CL=1uF, RL=5Ω		1.7		ms
V _{OUT} Falling Time, Tf ⁽⁶⁾	V _{IN} =5.5V, CL=1uF, RL=5Ω			0.5	ms
Voll i annig title, ti	V _{IN} =2.7V, CL=1uF, RL=5Ω			0.5	ms
Turn On Time, Ton (7)	C _L =100μF, RL=5Ω			3	ms
Turn Off Time, Toff ⁽⁸⁾	C _L =100μF, RL=5Ω			10	ms
Discharge Resistance			100		Ω
FLAG Deglitch Time		4	8	15	ms
EN Input Leakage		-1			μA
Reverse Leakage Current	OUT=5.5V, IN=GND		0.2		μA

NOTE:

4) Production test at +25°C. Specifications over the temperature range are guaranteed by design and characterization.

5) Measured from 10% to 90%.

Measured from 90% to 10%. 6)

Measured from (50%) EN signal to (90%) output signal.
 Measured from (50%) EN signal to (10%) output signal.

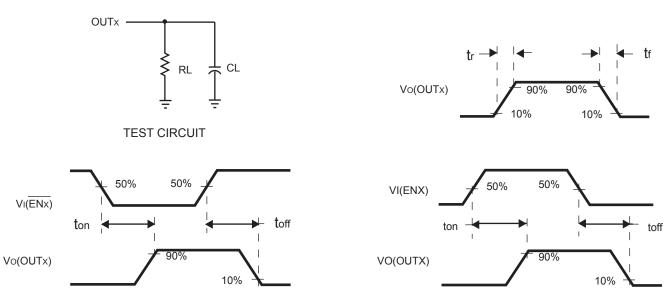


PIN FUNCTIONS

Pin # SOIC8	Pin # MSOP8E	Pin # QFN8E	Name	Description
1	1	1	GND	Ground.
2, 3	2, 3	2, 3	IN	Input Voltage. Accepts 2.7V to 5.5V input.
4	4	4	EN	Active Low: (MP62160), Active High: (MP62161)
5	5	5	FLAG	IN-to-OUT Over-current, active-low output flag. Open-Drain.
6, 7, 8	6, 7, 8	6, 7, 8	OUT	IN-to-OUT Power-Distribution Output (for all 3 output pins)

TYPICAL PERFORMANCE CHARACTERISTICS

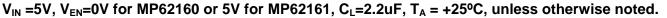
T_A = +25°C, unless otherwise noted.

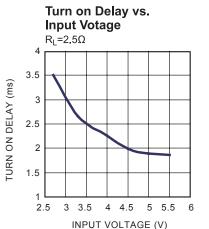


VOLTAGE WAVEFORMS
Figure 1—Test Circuit and Voltage Waveforms

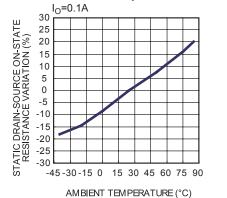




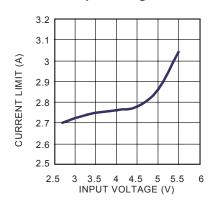


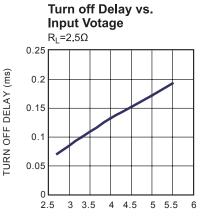


Static Drain-Source On-State Resistance Variation vs. Ambient Temperature



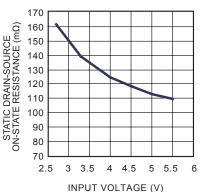
Current Limit vs. Input Voltage



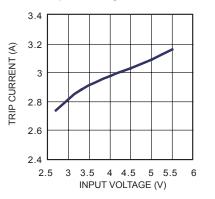


INPUT VOLTAGE (V)

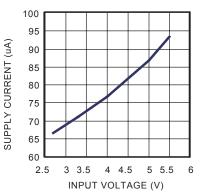
Static Drain-Source On-State Resistance vs. Input Voltage



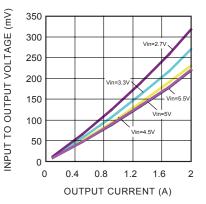
Threshold Trip Current vs. Input Voltage



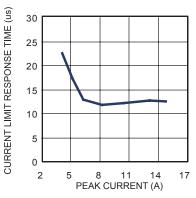
Supply Current, Output Enabled vs. Input Voltage



Input to Output Voltage vs. Load Current

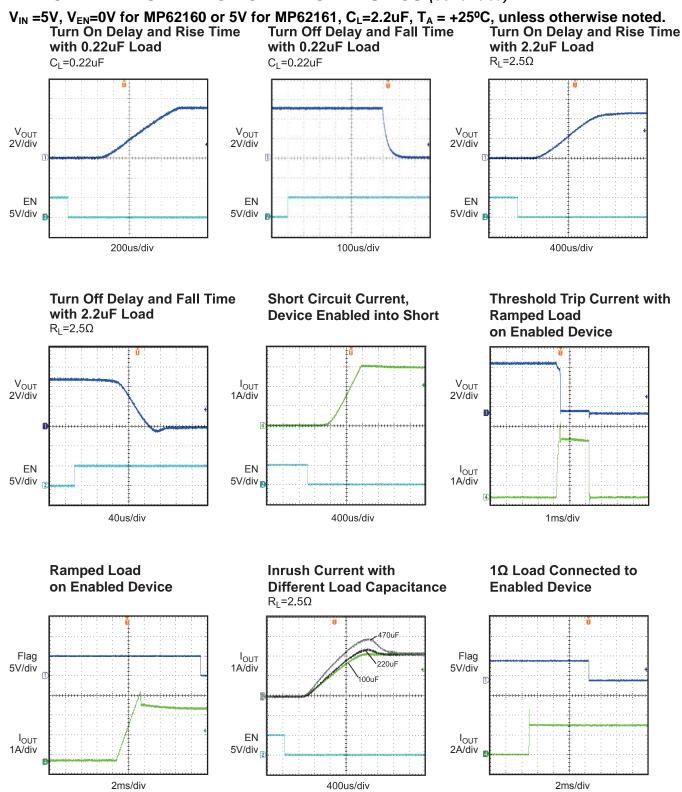


Current Limit Response Time vs. Peak Current



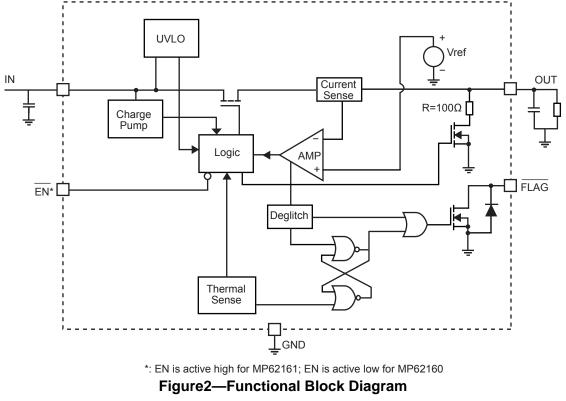


TYPICAL PERFORMANCE CHARACTERISTICS (continued)





FUNCTION BLOCK DIAGRAM



DETAILED DESCRIPTION

Over Current

When the load exceeds trip current (minimum threshold current triggering constant-current mode) or a short is present, MP62160/MP62161 switches into to a constant-current mode (current limit value). MP62160/MP62161 will be shutdown only if the overcurrent condition stays long enough to trigger thermal protection.

Trigger overcurrent protection for different overload conditions occurring in applications:

- The output has been shorted or overloaded before the device is enabled or input applied. MP62160/MP62161 detects the short or overload and immediately switches into a constant-current mode.
- 2) A short or an overload occurs after the device is enabled. After the current-limit circuit has been tripped (reached the trip current threshold), the device switches into constantcurrent mode. However, high current may flow for a short period of time before the current-limit circuit can react.

3) Output current has been gradually increased beyond the recommended operating current. The load current rises until the trip current threshold is reached or until the thermal limit of the device is exceeded. The MP62160/MP62161 is capable of delivering current up to the trip current threshold without damaging the device. Once the trip threshold has been reached, the device switches into its constant-current mode.

Flag Response

The FLAG pin is an open drain configuration. This FAULT will report a fail mode after an 8ms deglitch timeout. This is used to ensure that no false fault signals are reported. This internal deglitch circuit eliminates the need for extend components. The FLAG pin is not deglitched during an over temp. or a voltage lockout.



Thermal Protection

The purpose of thermal protection is to prevent damage in the IC by allowing exceptive current to flow and heating the junction. The die temperature is internally monitored until the thermal limit is reached. Once this temperature is reached, the switch will turn off and allow the chip to cool. The switch has a built-in hysteresis.

Under-voltage Lockout (UVLO)

This circuit is used to monitor the input voltage to ensure that the MP62160/MP62161 is operating correctly.

This UVLO circuit also ensures that is no operation until the input voltage reaches the minimum spec.

Enable

The logic pin disables the switch to reduce overall supply current .Once the EN pin reaches logic enable threshold, the MP62160/MP62161 is enabled.

Output Discharge

The part involves a discharge function that provides a resistive discharge path for the external output capacitor. The function will be active when the part is disabled (Input voltage is under UVLO or enable is deasserted) and it will be done in a very limited time.



APPLICATION INFORMATION

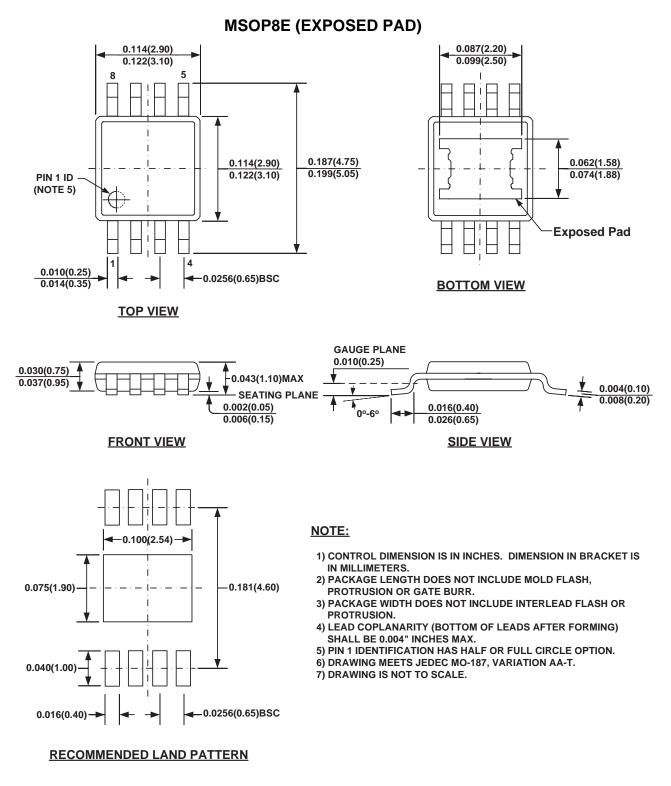
Power-Supply Considerations

Over 10μ F capacitor between IN and GND is recommended. This precaution reduces powersupply transients that may cause ringing on the input and improves the immunity of the device to short-circuit transients.

In order to achieve smaller output load transient ripple, placing a high-value electrolytic capacitor on the output pin(s) is recommended when the load is heavy.

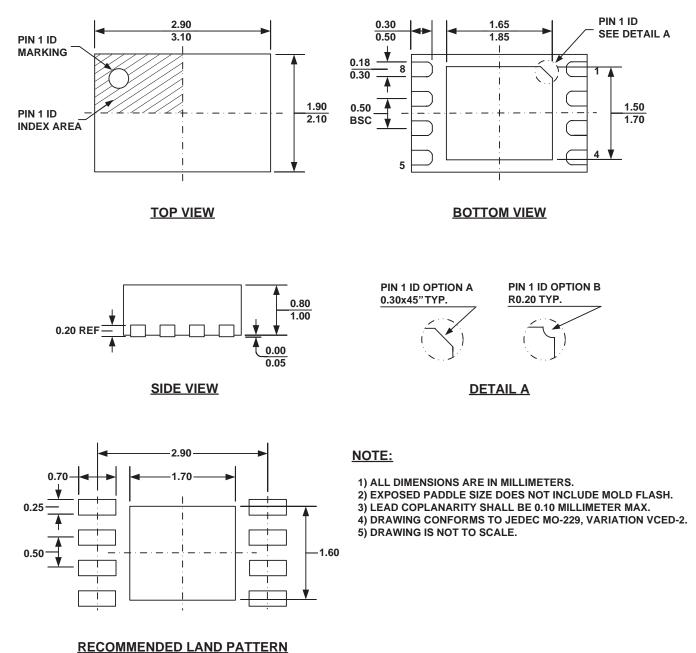


PACKAGE INFORMATION



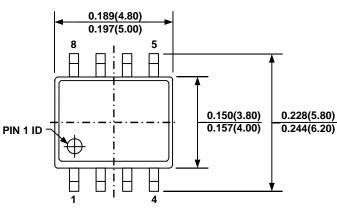


QFN8E (2mm x 3mm)

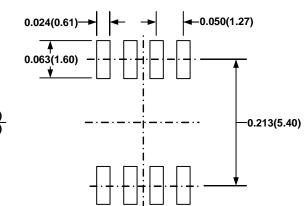




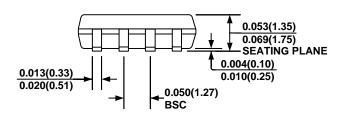
SOIC8

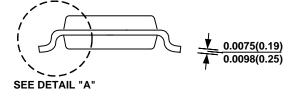


TOP VIEW

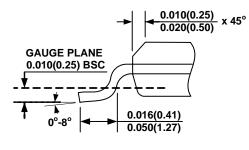


RECOMMENDED LAND PATTERN





SIDE VIEW



FRONT VIEW

DETAIL "A"

NOTE:

- 1) CONTROL DIMENSION IS IN INCHES. DIMENSION IN BRACKET IS IN MILLIMETERS.
- 2) PACKAGE LENGTH DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
- 3) PACKAGE WIDTH DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.
- 4) LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.004" INCHES MAX.
- 5) DRAWING CONFORMS TO JEDEC MS-012, VARIATION AA.
- 6) DRAWING IS NOT TO SCALE.

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